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(54) **An X-ray generation apparatus**

Eine Vorrichtung zur Röntgenstrahlerzeugung

Un appareil pour la génération de rayons-X

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Description

[0001] The present invention relates to an X-ray generation apparatus, specifically, one which makes it possible to generate high X-ray output by use of a smaller apparatus than the conventional size. In particular, the invention relates to an X-ray generation apparatus comprising an anticathode which comprises a high thermal conductive substrate and a target for generating X-rays when irradiated by electrons, said high thermal conductive substrate being diamond. Such an X-ray generated apparatus is disclosed in US-A-5 148 462.

[0002] The ordinary method which generates X-ray using irradiation of accelerated electrons to a target adapted an X-ray generation apparatus. However, when electrons, which are accelerated by some tens of thousands voltages, collide to the target, only 1% of the accelerated electron energy changes to X-ray energy and the remaining 99% is consumed as Joule's heat. It is essential to investigate how to effectively radiate one hundred times of thermal energy incidental to X-ray generation from the target, in order to obtain a high output X-ray generation apparatus. The range of X-ray strength generated by an apparatus depends on the target material and cooling ability. The generated X-ray energy can be increased by increasing electron irradiation energy within a range of the target not melted by irradiation of accelerated electrons.

[0003] Therefore, metal materials which have high thermal conductivity and high melting temperature are mainly used as the X-ray target, and the thermal energy is radiated by water cooling. Furthermore, in order to obtain high strength X-ray, a method by which the target is cooled while rotating has been developed. In this method, a portion of the target which is irradiated by electrons and emits X-ray, rotates one after another, the temperature of the target does not increase, and higher X-ray energy can be obtained compared with a fixed type target.

[0004] A diamond containing target, in which diamond is embedded in a copper substrate by powder sintering, is used and the target is cooled and rotated in an X-ray generation apparatus shown in Tokkai-Sho57(1982)-38548. However, it has been pointed out that the size of such X-ray apparatus increases, it is imperative to prevent vibration when rotating the target. Furthermore, there are problems with decreased efficiency of the electron beam when electron beam irradiates both copper and diamond.

[0005] An X-ray generation apparatus, in which an electron beam radiates in the direction of heat resistant single crystal axis, emits X-ray in the direction of the single crystal axis and a cooling means of the single crystal is prepared, as shown in Tokkai-Hei 2(1990)-309596. However, there are arguments that the target is cooled insufficiently because the electron radiating portion of the target is cooled through the peripheral portion of the single crystal.

[0006] An anticathode for X-ray generation which is made from a 2-layer structure of high heat conductive inorganic material and thin metal film, is shown in Tokkai-Hei 5(1993)-343193. Effective cooling is expected when the back portion of the high heat conductive inorganic material is cooled as shown in this prior art. However, when the target is adapted an X-ray generation apparatus which target is cooled at the peripheral portion (as shown in Tokkai-Hei 2-309596), the target does not have sufficient cooling ability because a considerable amount of thermal energy diffuses along the thin metal film which heat conduction resistance is rather high. The other subject is exfoliation of the thin metal film. A method of synthesizing diamond from the gaseous phase is disclosed in U.S. patent No. 4,767608 issued August 30, 1988, and in U.S. patent No. 4,434,188 issued February 28, 1984.

[0007] Responding to the controversy, the inventors have significantly improved the cooling efficiency and durability of the anticathode, miniaturized and simplified the X-ray generation apparatus, and have finally completed this high output and high strength X-ray generation apparatus invention.

[0008] According to the invention as disclosed in claim 1 there is provided an X-ray generation apparatus as initially defined, characterised in that said target is surrounded by the high thermal conductive substrate from one side of the substrate to the other, so as to be surrounded on all sides thereby and to be exposed at one end to the irradiating electrons, at said one side of said substrate.

[0009] Since thermal conductivity of the high heat conductive substrate of least 10 W/ cm.k is preferable, a diamond is required because it has high thermal conductivity and stability at high temperature. A natural single crystal diamond, a single crystal diamond synthesized under high pressure and a polycrystalline diamond synthesized by chemical vapor deposition can be used as a high heat conductive substrate. A desired shaped and comparatively large diamond can be obtained by the chemical vapor deposition. A cubic boron nitride crystal can be used as another material.

[0010] A material having the desired wave length of characteristic X-ray can be used as a target material, therefore, for example, Mo, W, Cu, Ag, Ni, Co, Cr, Fe, Ti, Rh or an alloy of the above element can be used..

[0011] Furthermore, to uniformly radiate the thermal energy generated at the target, it is preferable that the high heat conductive material is a disk and the target is arranged at the center of the substrate to penetrate the substrate.

[0012] In one embodiment, a high heat conductive substrate has at least one groove in the substrate to pass a coolant.

[0013] In another embodiment, a composite of a high heat conductive material arranged on a supporting material is provided and a groove is arranged in the side of the high heat conductive material of the intermediate

surface.

[0014] A further embodiment provides a high heat anticonductive material with a metal film on one side of the material, and also provides electric resistance of a high heat conductive material not more than $10^3 \Omega \cdot \text{cm}$ partially or wholly.

[0015] The high thermal conductive material is a diamond, preferably a gaseous phase synthesized diamond.

[0016] The portion of B-doped diamond which electric resistance is not more than $10^3 \Omega \cdot \text{cm}$ is used.

[0017] The invention will be better understood by referring, by way of example, to the accompanying drawings, in which:-

[0018] Fig. 1 shows a schematic cross-sectional view of an anticathode in accordance with this invention.

[0019] Fig. 2 shows a schematic view of an anticathode arranged on a holder.

[0020] Fig. 3 shows the pattern of groove to pass a coolant.

[0021] Fig. 4 shows a schematic view of an anticathode arranged in a holder.

[0022] The anticathode is composed of two adhered diamond plates and has a groove in it.

[0023] Fig. 5 shows a schematic view of an anticathode arranged in a holder,

[0024] The anticathode is composed of a diamond plate adhered to a supporting material and has a groove at the intermediate surface.

[0025] Fig. 6 shows a schematic cross-sectional view of a prior art anticathode.

[0026] Using the construction of this invention, X-ray output can be increased in any cooling system because the thermal energy generating at a target sufficiently radiates through high heat conductive substrate. This construction demonstrates remarkable efficiency, especially in cooling the anticathode at the peripheral portion of the substrate. The high thermal conductive material is arranged in the conduction direction of thermal energy in the present invention, cooling efficiency is remarkably improved compared with the conventional cathode plate, consequently high X-ray output can be generated.

[0027] It is preferable that the substrate is as thick as possible from the viewpoint of cooling ability, however, excessive thickness is undesirable from viewpoint of cost. The thickness of the substrate should range from $100 \mu\text{m}$ to 10 mm , and preferably from $300 \mu\text{m}$ to 5 mm . Furthermore, when a high thermal conductive substrate which has a groove to pass a coolant, is adapted to an X-ray generation apparatus, the apparatus obtains high cooling efficiency simply with a cooling system to flow a coolant. As a result, the X-ray generation apparatus generates high output and high strength X-ray.

[0028] Furthermore, when a high thermal conductive substrate which has a groove to pass a coolant and is adhered with an appropriate supporting material, is adapted to an anticathode of an X-ray generation apparatus, the apparatus obtains high cooling efficiency sim-

ply with a cooling system to flow a coolant. As a result, the X-ray generation apparatus generates high output and high strength X-ray. When a groove is prepared in a substrate or at a substrate side between the substrate and a supporting material, the cross section of the groove is preferably rectangular. The deeper (c) the groove, the higher the heat exchange efficiency of the anticathode. However an excessive depth of the groove is undesirable because mechanical strength of the anticathode becomes weak. The depth of the groove (c) must not be smaller than $20 \mu\text{m}$, and preferably not smaller than $50 \mu\text{m}$. The depth of the groove should be smaller than 90% of the substrate thickness and preferably smaller than 80%. The width of the groove is broader and heat exchange efficiency of the anticathode passway is higher.

[0029] However, excessive width of the groove lowers heat exchange efficiency, because the number of pathways decreases to maintain mechanical strength of the substrate. On the other hand, excessive or insufficient width of the groove as well as the distance between the grooves (b) is undesirable. The width of the groove and the distance between the grooves should range from $20 \mu\text{m}$ to 10 mm , and preferably from $40 \mu\text{m}$ to 2 mm . The lower limit of the ratio (a/b) of the width (a) and the distance (b) should be 0.02, and preferably 0.04. On the other hand the upper limit of the ratio should be 50, and preferably 25. The lower limit of the ratio (a/c) of the width (a) and the depth (c) is preferably 0.05 and more preferably 0.1. On the other hand, the upper limit of the ratio is preferably 100 and more preferably 50.

[0030] The most suitable width, distance and depth depend on the heat load and coolant pressure of the X-ray generation apparatus. The shape of the pathway can be not only rectangular but also semicircular, semielliptical and various complex shapes. Said (a), (b) and (c) are not always uniform and are changeable within the above range in one anticathode. A ratio of (groove surface) / (substrate surface) of the front view of the substrate should range from 2~90% and more preferably in a range of 10~80%. An angle between the side surface of the groove and the line perpendicular to the substrate is preferably not larger than 30° .

[0031] A non-diamond carbon layer is useful at the surface of the groove in a thickness of $1 \text{ nm} \sim 1 \mu\text{m}$. Said non-diamond layer can be formed in a non-oxidation atmosphere (for example in a non-active gas atmosphere) at a temperature of $1000 \sim 1500^\circ\text{C}$ for 0.5~10 hours. Existence of the non-diamond layer is observed by the raman spectrum method. Excellent wetting of the surface to coolant is preferable. It is also preferable that the contact angle between the surface and the coolant is not larger than 65° and desirably not larger than 60° .

[0032] Since there are hydrogen atoms on the diamond surface, a diamond repels coolant such as water. Wetting of a diamond can be increased by changing the hydrogen atoms to hydrophilic group (for example OH) including an oxygen atom. To improve the wetting of a

diamond, for example, a diamond is annealed in an oxidation atmosphere at temperatures of 500~800 °C for 10 minutes ~ 10 hours, or heated in a plasma of oxygen or gas which contains oxygen.

[0033] When oxygen plasma is used to make a groove, wetting of the groove is improved to some degree. The above means of improving wetting of the surface should be carried out after making a groove in the oxygen plasma.

[0034] When fluoro-carbon is used as coolant, it is preferable that a halogen atom such as a fluorine atom is combined with the surface of the groove. Such surface can be obtained by exposing the groove in a gas plasma, which contains a halogen atom such as CF₄. When the groove is exposed, for example, in RF plasma of CF₄, hydrogen atoms on the surface are changed to fluorine atoms.

[0035] It is defined that the fluorine atom combines with carbon atoms of the surface by XPS (X-ray photoelectron spectroscopy) spectrum observation. The XPS spectrum has a single peak of C_{1s} before the exposure but has many satellites of CF_n radicals after the exposure.

[0036] Such surface has good wettability to fluorine compounds. Other treatments expose the surface to gas plasma which contains nitrogen, boron and inert gas atoms. Water, air, inert gas such as nitrogen and argon, fluoro-carbon, liquid nitrogen, liquid oxygen and liquid helium can be used as a coolant.

[0037] Groove or a tube methods are explained hereunder wherein a tube is formed in the interior of a substrate and a groove is formed on a substrate interface between the substrate and a supporting material. The tube method is explained first.

[0038] A tube is formed in a substrate by laser machining as a pathway for the coolant. Providing a desired shaped plate made of a high thermal conductive material, a tube, made by collecting a laser beam at the side of the material and path way through which the coolant flows, is formed in the interior of the high thermal conductive material.

[0039] Another method of making a tube is to adhere the first high thermal conductive material having a groove to the second high thermal conductive material. A high thermal conductive material is worked into a desired shape. A groove is formed on one side of the first high thermal conductive material by laser beam machining or selective etching. The laser beam machining removes material by collecting a laser beam at the surface of the material and a groove is made at the surface. An optional groove can be obtained by this method. A groove is made on the surface of the substrate by collecting a laser beam of sufficient energy density on the surface of the high heat conductive material, and gradually moving the collected portion. A YAG laser, Excimer laser can be used for this machining. Excimer laser is preferable in view of optional depth, accuracy and repeatability of machining.

[0040] The wave length of the laser beam is preferred to range between 190~360 nm. Energy density of the laser beam should range between 10~10¹¹ W/cm².

[0041] Energy density of one pulse should range between 10⁻¹J/cm²~10⁶J/cm², when using a pulse laser. Furthermore, divergence angle of the laser beam from the generator is in a range of 10⁻²~5 × 10⁻¹ mrad and full width at half maximum of laser spectrum wave length is in a range of 10⁻⁴~1nm. Uniformity of energy distribution at the cross section of the laser beam should not be more than 10 % . When pulse laser is collected by a cylindrical lens or a cylindrical mirror, good machining is obtained.

[0042] A groove is formed by the etching method described below. After adequate masking is formed on the surface of the high thermal conductive material, the etching condition is selected so that only the material and not the masking is etched . When removing the masking, the first high thermal conductive material having the groove on the surface is obtained. It is known that the surface of diamond masked by Al or SiO₂ is selectively etched by oxygen or oxygen containing gas [Extended Abstract vol. 2 (The 53rd Autumn Meeting 1992); The Japan Society of Applied physics]. Using this technique, a groove is formed on diamond. Nitrogen or hydrogen can substitute oxygen or oxygen containing gas.

[0043] The first high thermal conductive material having desired grooves is adhered to the second high thermal conductive material, and then a substrate of extremely high heat irradiation efficiency is obtained. An exit and entrance of coolant can be formed on the second high thermal conductive material. The groove is formed only on the first high thermal conductive material in the above example, however, it is possible that the surface of the second high thermal conductive material having a groove is adhered to the surface of the first high thermal conductive material having a groove. But the process becomes complicated, and it is preferable that the groove is formed only on the first high thermal conductive material.

[0044] The adherence of the first high thermal conductive material to the second high thermal conductive material can be carried out by metalizing or adhering. It is possible for both of the two surfaces to be metalized by a prior technique, and then melting the metal to adhere. Metals such as Ti, Pt, Au, Sn, Pb, In and Ag are used for metalizing. For the adhesive (for example Ag/epoxi-group, Ag/polyimide-group and Au/epoxi-group), Ag-brazing material and other adhesives can be used. The thickness of the adhesive is in a range of 0.01~10μm.

[0045] When CVD diamond is used as the first high thermal conductive material, the groove is made by not only laser beam machining and etching but also selective growth by masking.

[0046] The selective growth method is described in Tokkai-Hei 1-104761 and Tokkai-Hei 1-123423. A mask-

ing material is arranged corresponding to the desired groove on a base such as Si, SiC, Cu, Mo, CBN, on which diamond is synthesized.

[0047] In this case, when diamond is synthesized more than 50 μ m thickness, diamond is grown even on the mask portion and as a result diamond entirely covers the base. The base is then removed by means such as a dissolution method, and the obtained diamond has a groove on the base side. Ti, SiO₂ and Mo are formed on the base as a mask by a known method. The advantage of this method is that breakage during machining rarely occurs because this method does not need shock or impact for machining.

[0048] Instead of forming a mask in the above method, it is possible for diamond to be synthesized on a base having a projection corresponding to the groove. After synthesizing diamond to the desired thickness, and then removing the base, free standing diamond having a groove on the plate side is obtained. Si, SiC and Mo can be used as a base. To improve the above method, adhering can be omitted. A mask is formed on a free standing diamond, and diamond is synthesized on the free standing diamond and then the mask is removed. A substrate having a tube can be obtained. Heat conductive efficiency of a substrate is further improved because an adhesive is not used. All of the above methods are preferable for making a substrate with a groove. The etching method is preferable for precisely forming micro grooves. The laser method is preferable for machining speed. The masking method is preferable for large grooves. The second high heat conductive material can be selected from B, Be, Al, Cu, Si, Ag, Ti, Fe, Ni, Mo, and W, their alloy and their compound such as carbide and nitride as a supporting material.

[0049] Accompanied by improved cooling ability, high output X-ray can be obtained in minute width of line since the target is not damaged by narrower than usual electron beam focus and increasing load to the target. The target which penetrates the substrate is earthed from a backside surface of the anticathode (opposite side of electron irradiation surface) and contributes to stabilizing X-ray generation. To earth the target from a backside surface, it is preferable for a thin metal film to be deposited on the back surface of the anticathode.

[0050] Furthermore, when gaseous phase synthesized diamond is used as a high thermal conductive material, it is easy to earth a target using electric conductive diamond as a substrate. The electric conductive diamond is arranged as a layer in the substrate or a whole substrate. The electric conductive diamond is synthesized by adding impurities in raw material gas. Such impurities are B, Al, Li, P, S and Se. Boron is preferable, because the addition of boron in diamond increases electric conductivity efficiently without prohibiting crystallization. The electric resistivity of the diamond is not more than 10³ Ω cm and preferable not more than 10² Ω cm.

[0051] In addition, when the direction of electron

beam coincides with the penetration direction of the target, an electron beam reaches the inner portion of the target and absorption ratio of the electron beam increases. For this reason, this invention is more useful to increase X-ray output than the target having 2-layer structures of high heat conductive inorganic material and thin metal film.

[0052] As explained above, the output and stability of X-ray can be increased using the present invented X-ray generation apparatus. Also, the apparatus can make the width of X-ray beam narrower, and produce more output compared to the conventional apparatus. Furthermore, since the above advantages are obtained without using a rotating anticathode target, the whole apparatus becomes a small and simple construction.

[0053] Therefore the apparatus can be made inexpensively. Furthermore, vibration accompanied by rotation is prevented.

[0054] These advantages make the invented apparatus possible to use in X-ray analyzed apparatus, X-ray deposition apparatus and such various X-ray apparatus.

[0055] This invention is now explained in the following examples.

Example 1.

[0056] A polycrystalline diamond substrate (heat conductivity 16.9w/cm. k) of 10 mm diameter and 1 mm thickness was prepared by chemical vapor deposition method. A pore of 0.2 mm diameter penetrated at the center of the substrate (2) by laser beam. A target of copper was arranged in the pore and then copper was evaporated on the back surface of the substrate and a cathode plate (1) as shown in Fig. 1 was prepared. Figure. 1 shows that thin film of copper (3) was uniformly deposited on the back surface of the diamond substrate, the filled portion (4) was constructed by filling up the penetrated pore with copper.

[0057] Then, the anticathode was set at the cooling holder (5) as shown in Fig. 2. This holder (5) is ring shaped, the anticathode (1) was fixed at the central hole portion and cooling water (6) circulated in the outer peripheral portion. Fig. 2 was arranged to cool the cathode plate from the outer peripheral portion. It is considered that a concrete means for set the anticathode (1) is brazing, pinching and melting filled powder. The copper film (3) at the back surface of the substrate was earthen to prevent charging up of copper metal target.

[0058] Electron beam of 0.15 mm diameter continuously irradiated exposed metal copper at the filled portion (4) from the surface of the substrate by a load of 10kw/mm². It was confirmed that the apparatus stably emitted X-ray after 1000 hours irradiation. The copper metal was examined after the test; there is no remarkable change in the surface condition.

[0059] The copper film was deposited on the back surface of the diamond target in this example, this copper

film was not intrinsic.

Example 2

[0060] Two scratched polycrystalline Si base was prepared at a size of 10mm diameter and 2 mm thickness. A diamond was synthesized on the Si base by microwave plasma-CVD method. Then the surface of the diamond was mechanically polished, and the Si base was dissolved by acid. The first diamond plate was of 10mm diameter and 600 μ m thickness. Heat conductivity was 17.9w/cm.k. The second diamond plate was of 10 mm diameter and 400 μ m thickness. Heat conductivity was 15.2w/cm.k. These two diamond plates were free-standing. Grooves were formed on the surface of the first diamond plate as shown in Fig. 3 by KrF Excimer laser of lineal focus and point focus. A depth of the groove is about 100 μ m, width of the groove is about 500 μ m and the distance between the grooves is about 400 μ m. Both of the diamond plates were coated in the order of Ti, Pt and Au by evaporation. Both of the coated surfaces were put together and then Au was melted to adhere the two diamond plates. The substrate was 10mm diameter and 1mm thickness and had a tube to pass a coolant.

[0061] A penetrating hole was formed in the substrate, and then filled with copper as explained in Example 1. Then a substrate was prepared by coating Cu on one side. Then the substrate was set in a cooling holder (15) as shown in Fig. 4. This holder (15) was designed so that water, which cooled the substrate, was supplied from the side of the substrate. Cu coated surface was earthed to prevent charging up a copper target.

[0062] An X-ray generation apparatus which used the substrate, was estimated under the same conditions as described in Example 1. Stability and durability are as excellent as Example 1.

Example 3

[0063] A scratched polycrystalline Si base was prepared at a size of 10mm diameter and 2mm thickness. A diamond was synthesized on the Si base by microwave plasma CVD method. Then the surface of the diamond was mechanically polished, and the Si base was dissolved by acid. The diamond plate was 10 mm diameter and 1 mm thickness. Heat conductivity of the free-standing diamond plate was 17.3w/cm.k. Grooves were formed on one side of the free-standing diamond plate, as shown in Fig. 3, by KrF Excimer laser of lineal focus and point focus. A depth of groove is about 300 μ m, width of the groove is about 500 μ m and the distance between the grooves is about 400 μ m

[0064] A penetrating hole was formed in the free-standing substrate by laser beam, and then filled with copper as in Example 1. A Cu-W alloy plate was prepared at a size of 10 mm diameter for a supporting material. The surface of the diamond substrate having

grooves was coated in the order of Ti, Pt and Au. One side of the Cu-W alloy plate was also coated in the order of Ti, Pt and Au. Both of the coated sides were adhered together by melting Au, and a substrate was obtained. Then the substrate was set in the cooling holder as shown in Fig. 6. This holder was designed so that water which cooled the substrate, was supplied from the side of the substrate.

[0065] An X-ray generation apparatus which used the substrate, was estimated under the same conditions as described in Example 1. Stability and durability were as excellent as in Example 1.

Example 4.

[0066] A scratched polycrystalline Si base was prepared at a size of 10 mm diameter and 2 mm thickness. A diamond was synthesized on the Si base by microwave plasma CVD method. Then the surface of the diamond was mechanically polished, and the Si base was dissolved by acid. The diamond plate was 10 mm diameter and 1 mm thickness. Heat conductivity of the free-standing diamond plate was 17.3w/cm.k. Because raw material gases contained B at the synthesizing diamond, electric resistance was 1.95 Ω cm.

[0067] A penetrating hole was formed in the free-standing diamond by laser beam, and then filled with copper as in Example 1. Then the substrate was set in the cooling holder. An X-ray generation apparatus which used the substrate, was estimated under the same conditions as described in Example 1. Stability and durability were as excellent as Example 1.

Comparative Example 1

[0068] A copper disk of 10 mm diameter and 1 mm thickness was set in the holder (5) as shown in Fig. 2.

[0069] The disk was continuously irradiated by an electron beam of 0.15 mm diameter and it was found that the X-ray did not generate stably under a load of 4kw/mm², and that the irradiated portion of the disk was considerably damaged by heat energy after 100 hours irradiation.

Comparative Example 2

[0070] A polycrystalline diamond disk substrate (7) of 10 mm diameter and 1 mm thickness was prepared and copper was evaporated on one side of the disk as shown in Fig. 6. Then, the disk was set in the holder (5) as shown in Fig. 2.

[0071] Results of X-ray generation tests, which were carried out as Example 1 and comparative Example 1, showed that stable X-ray was obtained after 100 hours testing under a load of 4 kw/mm², and remarkable change was not recognized at the surface of the metal copper film. Under a load of 10 kw/mm², however, damage was observed and output of X-ray gradually de-

creased, at the irradiated portion of metal copper film (8) after 500 hours irradiation.

Claims

1. An X-ray generation apparatus comprising an anticathode which comprises a high thermal conductive substrate (2) and a target (4) for generating X-rays when irradiated by electrons, said high thermal conductive substrate being diamond, characterised in that said target (4) penetrates the high thermal conductive substrate (2) from one side of the substrate to the other, so as to be surrounded on all sides thereby and to be exposed at one end to the irradiating electrons, at said one side of said substrate. 10
2. An X-ray generation apparatus according to claim 1, wherein said high thermal conductive substrate (2) has at least one pathway to pass a coolant in the substrate. 20
3. An X-ray generation apparatus according to claim 1, wherein said high thermal conductive substrate (2) is set on a supporting material, and a groove (7) is formed in the substrate side at an interface between the supporting material and said high thermal conductive substrate (2). 25
4. An X-ray generation apparatus according to any preceding claim, wherein said target (4) is made from one metal selected from the group consisting of Mo, W, Cu, Ag, Ni, Co, Cr, Fe, Ti and Rh or an alloy mainly including at least one metal selected from the group. 30
5. An X-ray generation apparatus according to claim 1, wherein said high thermal conductive substrate (2) is coated with metal film (3) on said other side of the substrate. 35
6. An X-ray generation apparatus according to claim 1, wherein the electric resistance of the high thermal conductive substrate is partially or wholly not more than $10^3 \Omega \cdot \text{cm}$. 40
7. An X-ray generation apparatus according to any preceding claim, wherein diamond is synthesized by a gaseous phase synthesized method. 45
8. An X-ray generation apparatus according to claim 6, wherein said high thermal conductive substrate of not more than $10^3 \Omega \cdot \text{cm}$ of electric resistance is B-doped synthesized diamond from gaseous phase. 50
9. An X-ray generation apparatus according to any preceding Claim, wherein the anticathode is fixed 55

within a ring shaped cooling holder (5).

Patentansprüche

1. Röntgenstrahl-Erzeugungsgerät, das eine Antikathode aufweist, die ein stark wärmeleitendes Substrat (2) aufweist, und ein Target (4) zum Erzeugen von Röntgenstrahlen, wenn es durch Elektronen bestrahlt wird, wobei das stark wärmeleitende Substrat ein Diamant ist, dadurch gekennzeichnet, daß das Target (4) das stark wärmeleitende Substrat (2) von einer Seite des Substrats zur anderen durchdringt, um an allen Seiten von ihm umgeben zu sein und um an einem Ende an der einen Seite des Substrats gegenüber den bestrahlenden Elektronen freigelegt zu sein.
2. Röntgenstrahl-Erzeugungsgerät nach Anspruch 1, wobei das stark wärmeleitende Substrat (2) wenigstens einen Durchgang zum Durchlassen eines Kühlmittels im Substrat hat.
3. Röntgenstrahl-Erzeugungsgerät nach Anspruch 1, wobei das stark wärmeleitende Substrat (2) auf einem Stütz- bzw. Trägermaterial eingestellt ist und eine Nut (7) in der Substratseite an einer Schnittfläche zwischen dem Trägermaterial und dem stark wärmeleitenden Substrat (2) ausgebildet ist.
4. Röntgenstrahl-Erzeugungsgerät nach einem der vorangehenden Ansprüche, wobei das Target (4) aus einem Metall hergestellt ist, das aus der Gruppe ausgewählt ist, die aus Mo, W, Cu, Ag, Ni, Co, Cr, Fe, Ti und Rh besteht oder einer Legierung, die hauptsächlich wenigstens ein aus der Gruppe ausgewähltes Metall enthält.
5. Röntgenstrahl-Erzeugungsgerät nach Anspruch 1, wobei das stark wärmeleitende Substrat (2) mit einem Metallfilm (3) auf der anderen Seite des Substrats überzogen bzw. beschichtet ist.
6. Röntgenstrahl-Erzeugungsgerät nach Anspruch 1, wobei der elektrische Widerstand des stark wärmeleitenden Substrats teilweise oder gänzlich nicht größer als $10^3 \Omega \cdot \text{cm}$ ist.
7. Röntgenstrahl-Erzeugungsgerät nach einem der vorangehenden Ansprüche, wobei ein Diamant durch ein Gasphasen-Syntheseverfahren synthetisiert ist.
8. Röntgenstrahl-Erzeugungsgerät nach Anspruch 6, wobei das stark wärmeleitende Substrat mit einem elektrischen Widerstand von nicht größer als $10^3 \Omega \cdot \text{cm}$ ein B-dotierter Synthese-Diamant aus einer Gasphase ist.

9. Röntgenstrahl-Erzeugungsgerät nach einem der vorangehenden Ansprüche, wobei die Antikathode innerhalb einer ringförmigen Kühlungshalterung (5) fixiert ist.

5

Revendications

1. Appareil de production de rayons X comprenant une anticathode qui comprend un substrat de conductivité thermique élevée (2) et une cible (4) pour produire des rayons X lorsqu'elle est irradiée par des électrons, ledit substrat de conductivité thermique élevée étant du diamant, caractérisé en ce que ladite cible (4) pénètre dans le substrat de conductivité thermique élevée (2) à partir d'un côté du substrat vers l'autre côté, afin d'être par là entourée sur tous les côtés et d'être exposée à une extrémité aux électrons rayonnants sur ledit un côté dudit substrat. 10 15 20
2. Appareil de production de rayons X selon la revendication 1, dans lequel ledit substrat de conductivité thermique élevée (2) présente au moins une voie de passage pour faire passer un réfrigérant dans le substrat. 25
3. Appareil de production de rayons X selon la revendication 1, dans lequel ledit substrat de conductivité thermique élevée (2) est fixé sur un matériau de support et une rainure (7) est formée dans le côté du substrat sur une interface entre le matériau de support et ledit substrat de conductivité thermique élevée (2). 30 35
4. Appareil de production de rayons X selon l'une quelconque des revendications précédentes, dans lequel ladite cible (4) est constitué d'un métal choisi parmi Mo, W, Cu, Ag, Ni, Co, Cr, Fe, Ti et Rh ou un alliage comprenant principalement au moins un métal choisi parmi ceux-ci. 40
5. Appareil de production de rayons X selon la revendication 1, dans lequel ledit substrat de conductivité thermique élevée (2) est revêtu d'un film de métal (3) sur ledit autre côté du substrat. 45
6. Appareil de production de rayons X selon la revendication 1, dans lequel la résistance électrique du substrat de conductivité thermique élevée est partiellement ou totalement d'au plus $10^3 \Omega \cdot \text{cm}$. 50
7. Appareil de production de rayons X selon l'une quelconque des revendications précédentes, dans lequel du diamant est synthétisé par un procédé de synthèse en phase gazeuse. 55
8. Appareil de production de rayons X selon la reven-

dication 6, dans lequel ledit substrat de conductivité thermique élevée de résistance électrique d'au plus $10^3 \Omega \cdot \text{cm}$ est du diamant dopé avec B synthétisé à partir d'une phase gazeuse.

9. Appareil de production de rayons X selon l'une quelconque des revendications précédentes, dans lequel l'anticathode est fixée à l'intérieur d'un support de réfrigération en forme d'anneau (5).

FIG. 1

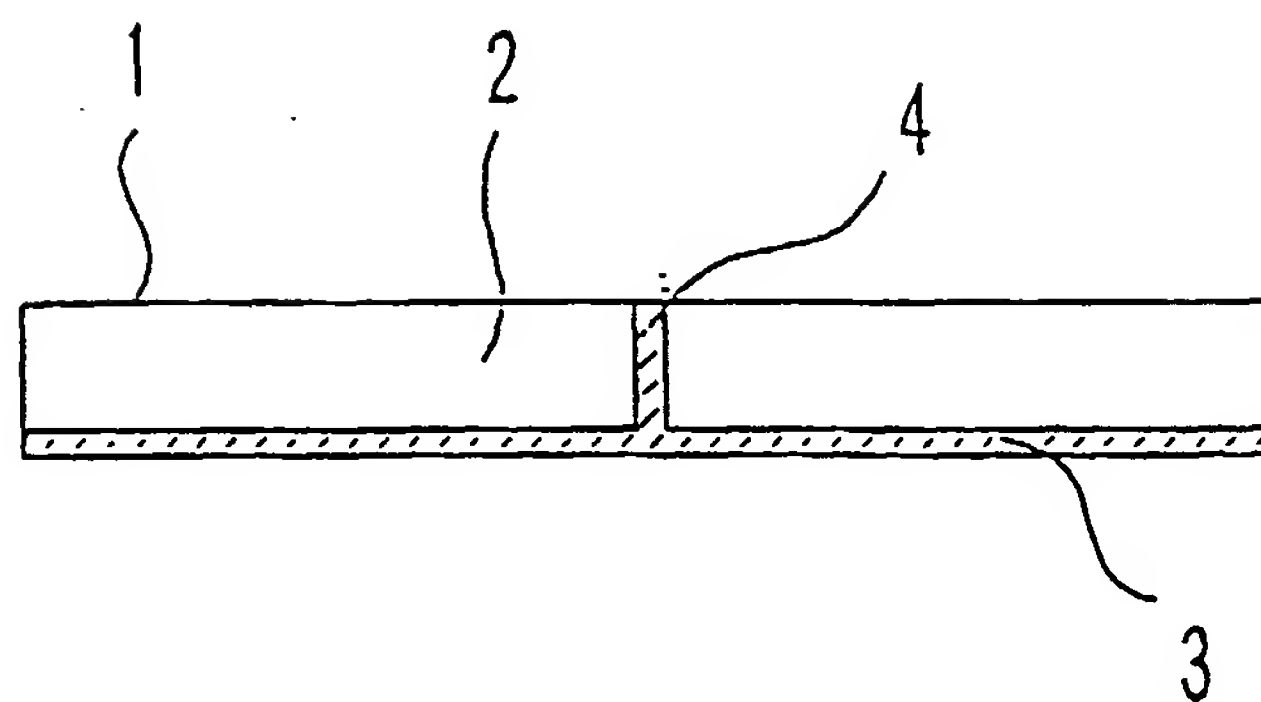


FIG. 2

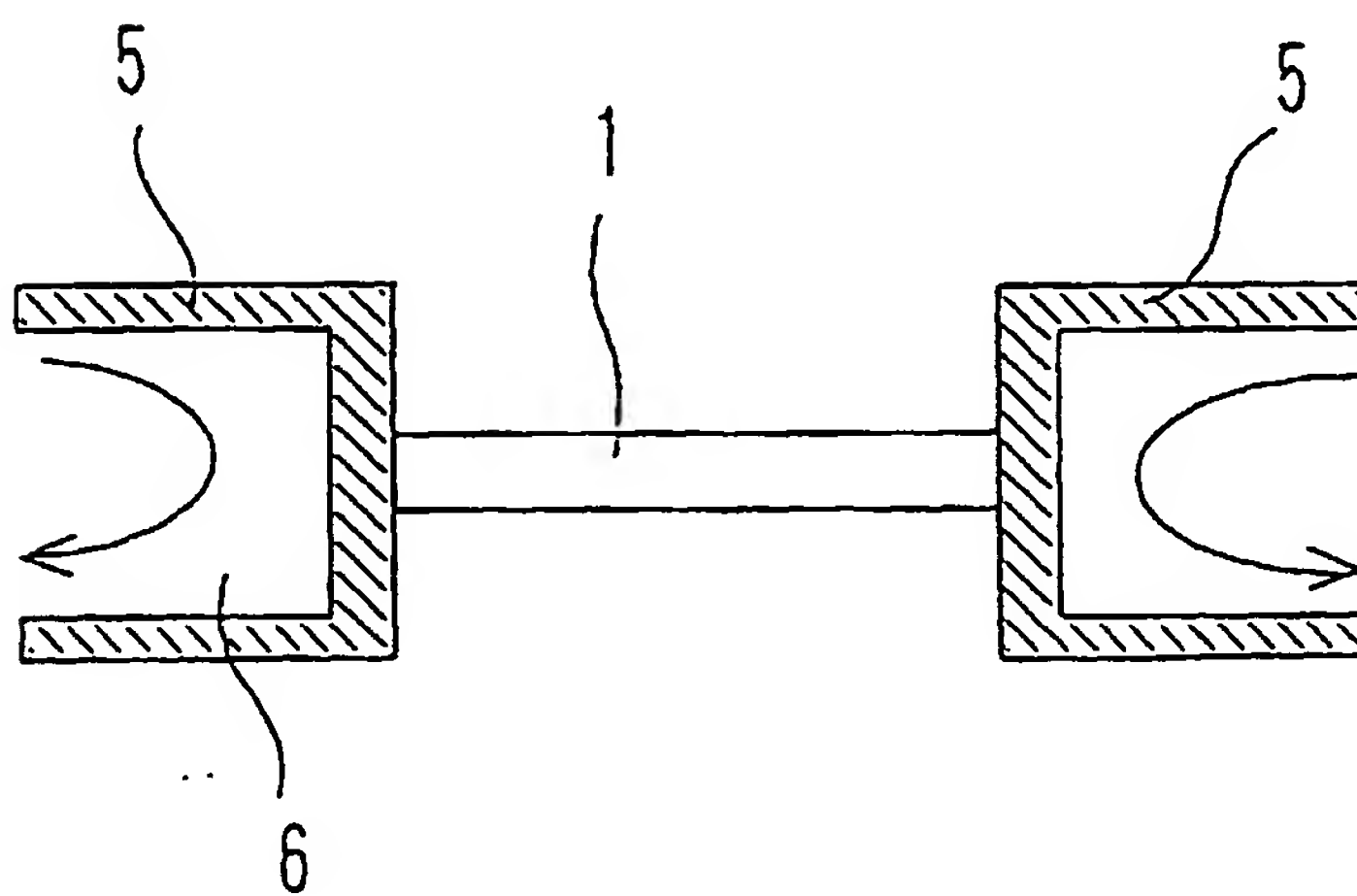


FIG. 3

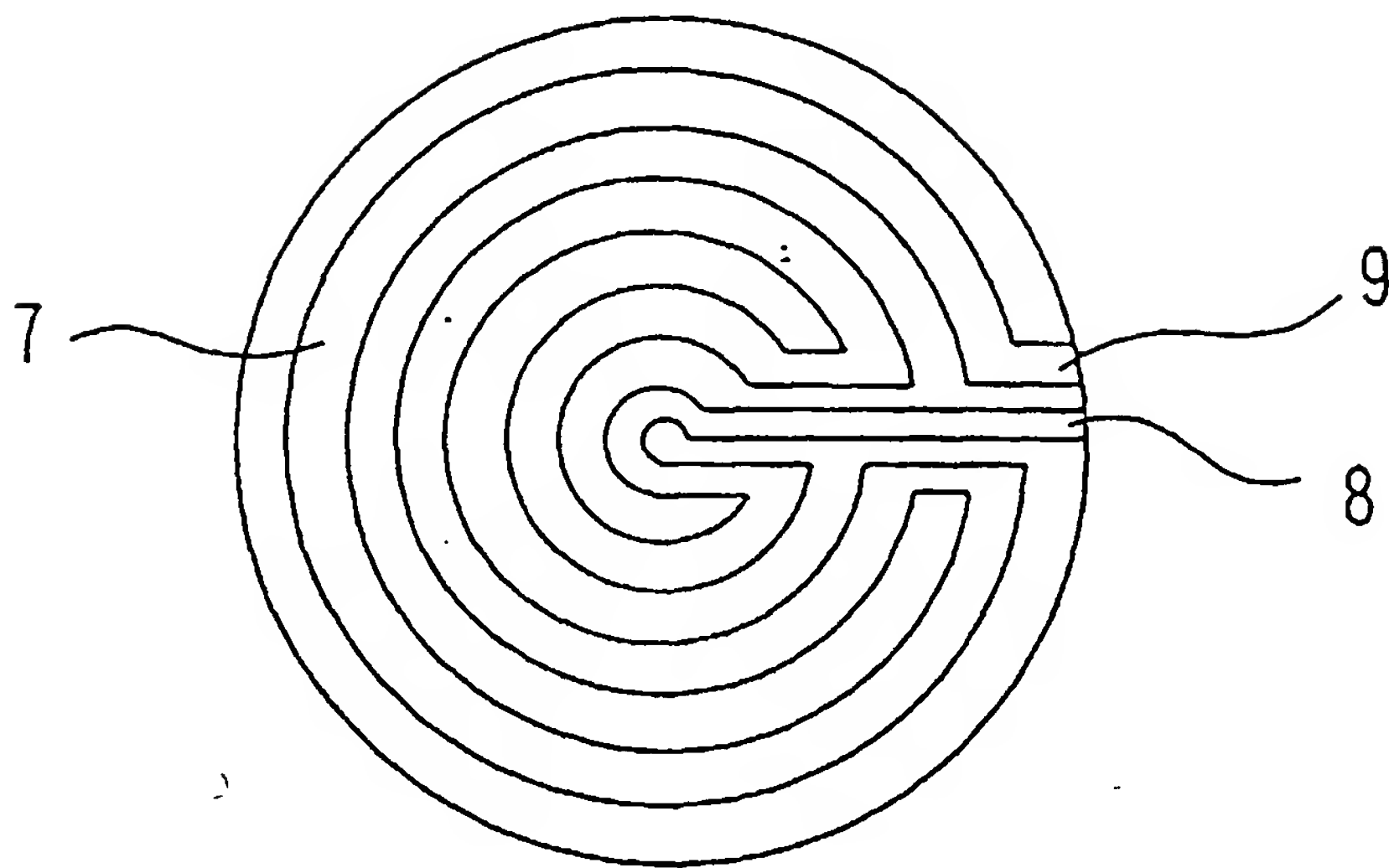


FIG. 4

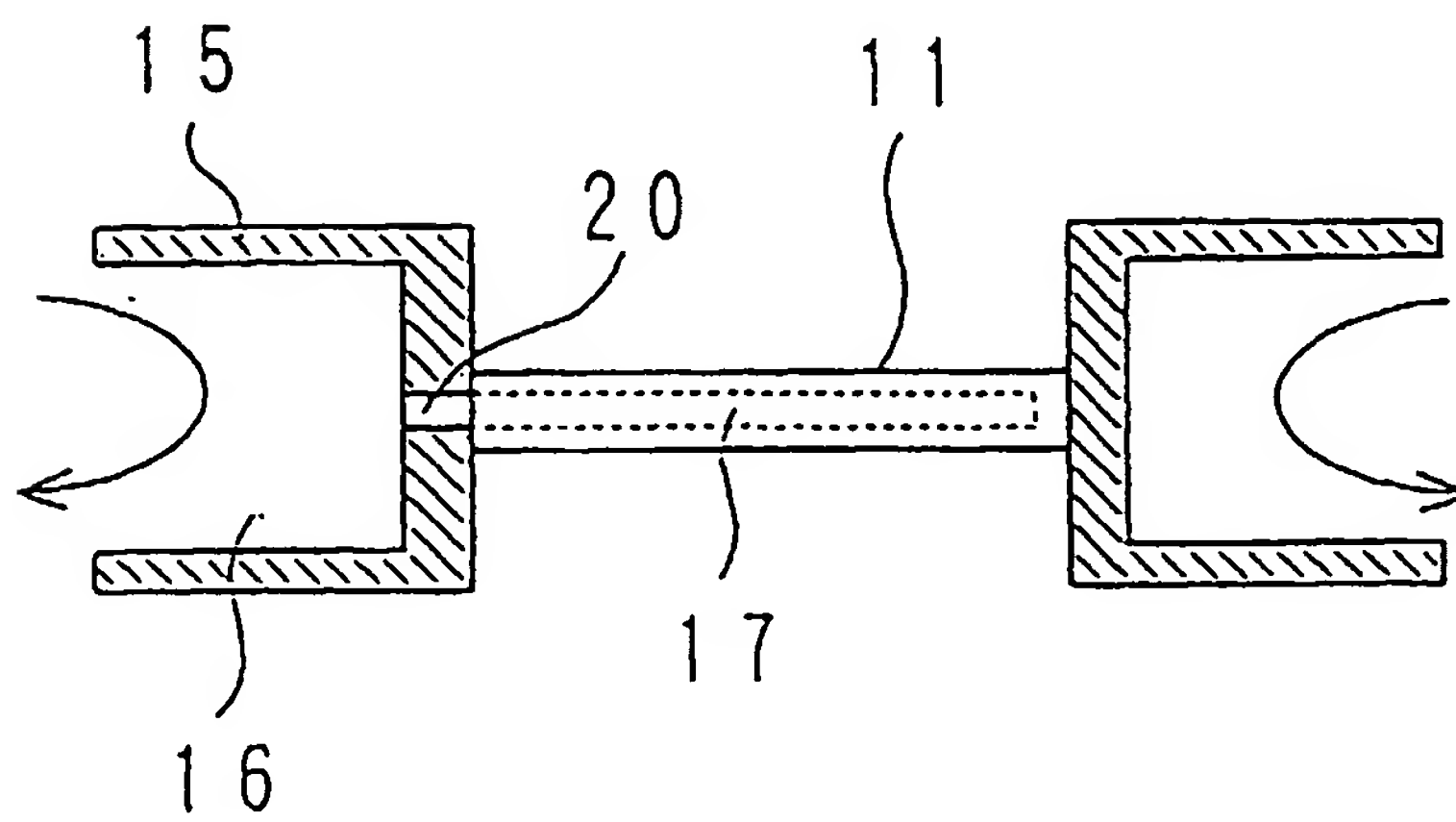


FIG. 5

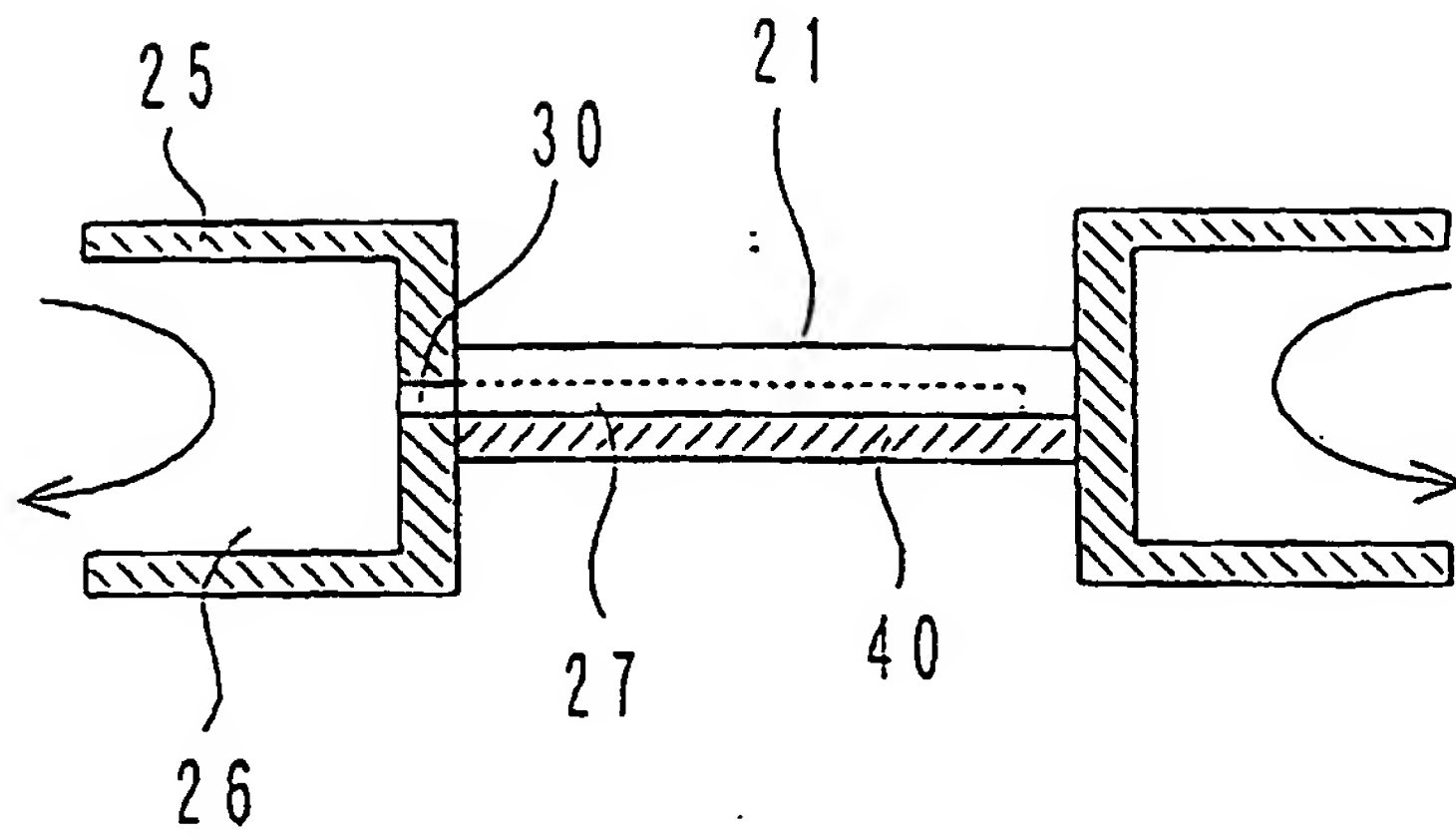


FIG. 6

